	Material Compo © Copyright 2005. IP © International and Pan	C, Bannockb	urn, Illinois. A	All rights reserved untions.	Inder both This level	documen parts, the	nt is a declaration er	on of the substand acompasses all lo	es within the wer level mat	manufacture erials for wh	er listed ite hich the ma	em. Note: i anufacturer	f the item is an as has engineering	sembly with low responsibility.
752-21.1					Form Type * Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					als and Mfg Information			
upplie	r Information													
ompany	name*	Company unique ID			U	Unique ID Authority				Response Date*				
nsemi											2025-07-07			
Contact Name			Title - Contact			P	Phone - Contact*				Email - Contact*			
Product-I	Env-Stewards		Product Enviro Compliance			Ν	NA				Product-Env-Stewards@onsemi.com			
uthorize	ed Representative*		Title - Representative			P	Phone - Representative*				Email - Representative*			
roduct-I	Env-Stewards		Product Enviro Compliance			N	NA				Product-Env-Stewards@onsemi.com			
			n Number Mfr Item Name			I	Effective Date Version Manufacturing Site		ing Site	W	/eight*	UOM	Unit Type	
			HV Switcher for Low Power offline SMPS		MPS 2	2025-07-07 CN		CNW	CNW		71.77	mg	Each	
Ianufa	cturing Proccess Informat	ion												I
	Terminal Plating / Grid Array Material		Ferminal Base Alloy J-STD-020 N		J-STD-020 MSL Rati	ng	Peak Process Body Temperat		ature Max Ti	ure Max Time at Peak Temper		re Numb	er of Reflow Cyc	eles
	Matte Tin (Sn) - annealed		CU Alloy NA		NA		0 C 30			seconds 3				
omments	6													
or more	information regarding material of	composition	please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU												
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of							
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all							
Exemption List Version	EL-2011/534/EU											
Declaration Signature												
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the							
Supplier Digital Signature Ra	stislav Drska	Le										

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	2.19	mg	Supplier	Silicon (Si)	7440-21-3		2.19	mg
Die Attach	8.92	mg	Supplier	Silver (Ag)	7440-22-4		6.69	mg
			Supplier	Epoxy resins	129915-35-1		2.23	mg
Lead Frame	131.05	mg	Supplier	Silver (Ag)	7440-22-4		0.9173	mg
			Supplier	Zinc (Zn)	7440-66-6		0.2621	mg
			Supplier	Iron (Fe)	7439-89-6		3.4073	mg
			Supplier	Copper (Cu)	7440-50-8		126.4632	mg
Mold Compound-Black	317.53	mg		Epoxy resin	proprietary data		15.8765	mg
			Supplier	Phenolic Resin	Proprietary Data		15.8765	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		6.3506	mg
			Supplier	Carbon Black (C)	1333-86-4		1.5876	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		277.8387	mg
Plating	11.9	mg	Supplier	Tin (Sn)	7440-31-5		11.9	mg
Wire Bond	0.18	mg	Supplier	Palladium (Pd)	7440-05-3		0.0018	mg
			Supplier	Copper (Cu)	7440-50-8		0.1782	mg

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 signa range of distribution unless otherwise noted)